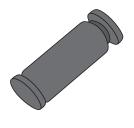


Diac in SMD MINIMELF package



MINIMELF

Features

- V_{BO}: 32 V
- Breakover voltage range: 28 V to 36 V
- ECOPACK compliant

Applications

- Triggering device for Triac or SCR based motor / light dimmer
- 32 V trigger device for oscillator circuit
- Start up triggering in lighting ballast for CFL, TL or LED lamps

Description

Functioning as a trigger diode with a fixed voltage reference, the TMMDB3 can be used in conjunction with Triacs for simplified gate control circuits or as a starting element in fluorescent lamp ballasts.

Product status link		
TMMDB3		
Product summary		
Part number	V _{BO}	
TMMDB3	28 - 36 V	



1 Characteristics

Table 1. Absolute maximum ratings (limiting values), $T_j = 25$ °C unless otherwise specified

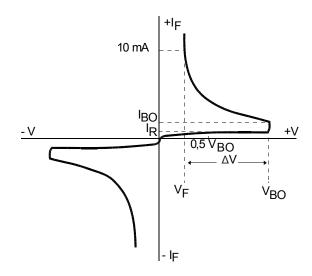
Symbol	Parameter	Value	Unit
I _{TRM}	Repetitive peak on-state current, t _p = 20 μs, F = 120 Hz	2	Α
T _{stg}	Storage junction temperature range -40 to +125		
Tj	Operating junction temperature range -40 to +125		°C

Table 2. Electrical characteristics (T_j = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions		Value	Unit
V _{BO} Breakover voltage ⁽¹⁾	Breakover voltage ⁽¹⁾			28	
		C = 10 nF ⁽²⁾	Тур.	32	V
			36		
I V _{BO1} - V _{BO2} I	Breakover voltage symmetry	C = 10 nF ⁽²⁾	Max.	3	V
Δ٧	Dynamic breakover voltage ⁽¹⁾	V _{BO} and V _F at 10 mA	Min.	5	V
V _O	Output voltage ⁽¹⁾	See Figure 2. Test circuit , (R = 20Ω)	Min.	5	V
I _{BO}	Breakover current ⁽¹⁾	C = 10 nF ⁽²⁾	Max.	50	μΑ
t _r	Rise time ⁽¹⁾	See Figure 3. Rise time measurement	Max.	2	μs
I _R	Leakage current ⁽¹⁾	$V_R = 0.5 \times V_{BO} \text{ max}$	Max.	10	μΑ
l _P	Peak current ⁽¹⁾	See Figure 2. Test circuit	Min.	0.30	Α

- 1. Applicable to both forward and reverse directions.
- 2. Connected in parallel to the device

Figure 1. Voltage - current characteristic curve.



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Figure 2. Test circuit

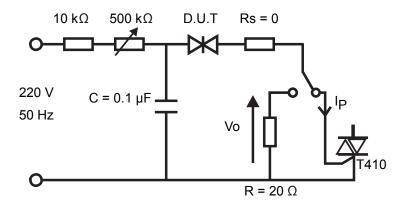
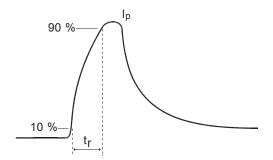


Figure 3. Rise time measurement



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1.1 Characteristics curves

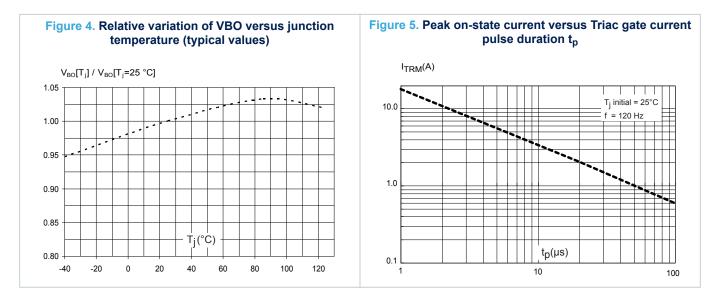
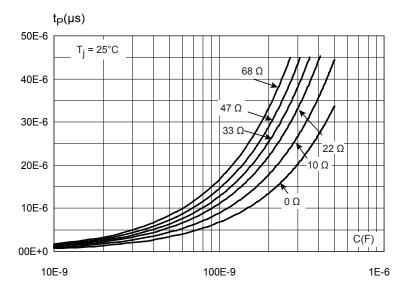


Figure 6. Triac gate current pulse duration t_p (to have $I_P > 50$ mA) versus Rs and C values (typical values)



Note: according to Figure 2. Test circuit.

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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 MINIMELF package information

A ØB

Figure 7. MINIMELF package outline

Table 3. MINIMELF package mechanical data

Dim.	mm					
Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	3.30	3.50	3.70	0.130	0.138	0.146
В	1.59	1.65	1.70	0.063	0.065	0.067
С	0.40	0.50	0.60	0.016	0.020	0.024
D		1.50			0.059	

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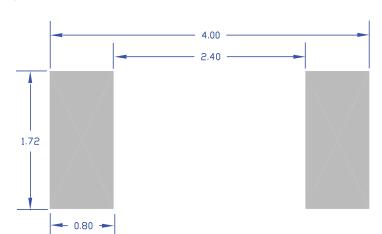


Figure 8. MINIMELF recommended footprint (dimensions are in mm)

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3 Ordering information

Figure 9. Ordering information scheme

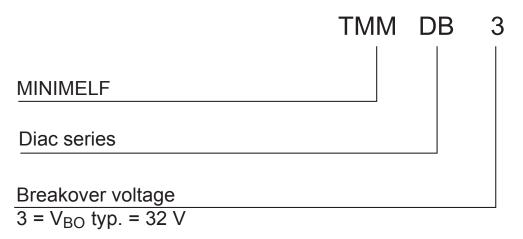


Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TMMDB3	NA	MINIMELF	0.049 g	2500	Tape and reel

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Revision history

Table 5. Document revision history

Date	Version	Changes
29-Jan-2009	3	First release.
07-May-2019	4	Updated Table 3 and Figure 8. Minor text change to improve readability.

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